

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Akihiko ENDO et al.

Mail Stop PCT

Appl. No. : Not Yet Assigned (U.S. National Phase of PCT/JP2004/012633)

I. A. Filed : September 1, 2003

For : METHOD FOR MANUFACTURING BONDED WAFER


CLAIM OF PRIORITY

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop PCT
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

Applicant hereby claims the right of priority granted pursuant to 35 U.S.C. 119 and 365 based upon Japanese Application No. 2003-309239, filed September 1, 2003. The International Bureau already should have sent a certified copy of the Japanese application to the United States designated office. If the certified copy has not arrived, please contact the undersigned.

Respectfully submitted,
Akihiko ENDO et al.


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February 28, 2006
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